



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application

Inventor: Richard M. Ehrlich  
Appln. No.: 10/624,265  
Confirm. No.: 7315  
Filed: July 22, 2003  
Title: METHODS FOR CONDITIONAL  
SERVOWRITING

PATENT APPLICATION

Art Unit:  
Examiner:



23910

PATENT TRADEMARK OFFICE

**DECLARATION FOR PATENT APPLICATION**

As a below named inventor, I hereby declare that my residence, mailing address and citizenship are as stated below next to my name. I believe that I am the original, first and sole inventor (if one name is listed below), or first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

**METHODS FOR CONDITIONAL SERVOWRITING**

the specification of which (check applicable ones):

\_\_\_\_\_ is filed herewith;  
\_\_\_\_\_ ☒ was filed with the above-identified "Filed" date and "SC/Serial No."  
\_\_\_\_\_ was amended on (or amended through) \_\_\_\_\_.

I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment(s) referred to above. I acknowledge the duty to disclose information which is material to the examination of the application in accordance with Title 37, Code of Federal Regulations, §1.56.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true, and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under §1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

(1) Full name of sole  
or first inventor: Richard M. Ehrlich

(1) Residence: 12092 Marilla Drive  
Saratoga, CA 95070

(1) Mailing Address: (Same)

(1) Citizenship: U.S.A.

(1) Inventor's signature: 

(1) Date: 1/13/04

\*\*\*\*\*

(2) Full name of second  
joint inventor: \_\_\_\_\_

(2) Residence: \_\_\_\_\_

(2) Mailing Address: \_\_\_\_\_

(2) Citizenship: \_\_\_\_\_

(2) Inventor's signature: \_\_\_\_\_

(2) Date: \_\_\_\_\_

\*\*\*\*\*